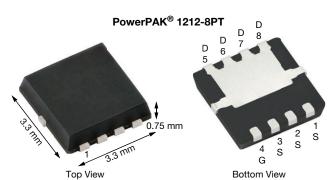
Vishay Siliconix

# N-Channel 30 V (D-S) MOSFET



PRODUCT SUMMARY					
V <sub>DS</sub> (V)	30				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.00538				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.00702				
Q <sub>g</sub> typ. (nC)	6.6				
I <sub>D</sub> (A) <sup>a</sup>	72				
Configuration	Single				

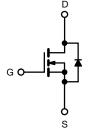
#### **FEATURES**

- TrenchFET® Gen IV power MOSFET
- 100 % R<sub>g</sub> and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



### **APPLICATIONS**

- High power density DC/DC
- Synchronous rectification
- VRMs and embedded DC/DC
- Battery protection



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK 1212-8PT
Lead (Pb)-free and halogen-free	SiSA14BDN-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		$V_{DS}$	30	V	
Gate-source voltage		$V_{GS}$	+20, -16		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		72		
	T <sub>C</sub> = 70 °C		58		
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	21 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		17 <sup>b, c</sup>	_	
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	130	A	
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		41		
	T <sub>A</sub> = 25 °C	I <sub>S</sub>	3.4 b, c		
Single pulse avalanche current	L = 0.1 mH	I <sub>AS</sub>	15		
Single pulse avalanche energy	L = 0.1 IIII	E <sub>AS</sub>	11.3	mJ	
Maximum power dissipation	T <sub>C</sub> = 25 °C		45	w	
	T <sub>C</sub> = 70 °C		29		
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.8 b, c		
	T <sub>A</sub> = 70 °C		2.4 b, c		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Soldering recommendations (peak temperature) d, e			260		

THERMAL RESISTANCE RATINGS						
PARAMETER		SMYBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b, f	t ≤ 10 s	R <sub>thJA</sub>	26	33	°C/W	
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	2.2	2.8	- C/VV	

#### **Notes**

a. Based on  $T_C = 25$  °C

S21-1222-Rev. A, 20-Dec-2021

- b. Surface mounted on 1" x 1" FR4 board
- t = 10 s
- See solder profile (<a href="www.vishay.com/doc?73257">www.vishay.com/doc?73257</a>). The PowerPAK 1212-8PT is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- Maximum under steady state conditions is 63 °C/W

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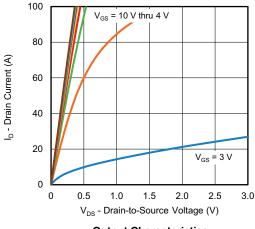
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	<u> </u>		-!			
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30	-	-	
Drain-source breakdown voltage <sup>(c)</sup> (transient)	V <sub>DSt</sub>	$V_{GS} = 0 \text{ V}, I_{D(aval)} = 40 \text{ A}, $ $t_{transcient} \le 50 \text{ ns}$		-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	1 250 4	-	15.2	-	mV/°C
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-4.7	-	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.1	-	2.2	V
Gate-source leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = +20, -16 V	-	-	± 100	nA
Zono della collega della consul		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μA
Zero gate voltage drain current	IDSS	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$	-	-	10	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30	-	-	Α
		$V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	-	0.00370	0.00538	Ω
Drain-source on-state resistance a	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 8 A	-	0.00540	0.00702	
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 20 A	-	65	-	S
Dynamic <sup>b</sup>		-	L	<u> </u>		
Input capacitance	C <sub>iss</sub>		-	917	-	pF
Output capacitance	Coss		-	389	-	
Reverse transfer capacitance	C <sub>rss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	37	-	
C <sub>rss</sub> /C <sub>iss</sub> ratio			-	0.04	0.08	
		V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A	-	14	22	nC
Total gate charge	$Q_g$		-	6.6	10	
Gate-source charge	$Q_{gs}$	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$	-	2.93	-	
Gate-drain charge	Q <sub>gd</sub>		-	1.61	-	
Output charge	Q <sub>oss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}$	-	11	-	
Gate resistance	$R_{g}$	f = 1 MHz	0.6	2.8	5.6	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	10	20	
Rise time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, R_{L} = 1.5 \Omega$	-	5	10	
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	16	30	
Fall time	t <sub>f</sub>		-	5	10	
Turn-on delay time	t <sub>d(on)</sub>		-	15	30	ns
Rise time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, R_1 = 1.5 \Omega$	-	30	60	
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	17	35	
Fall time	t <sub>f</sub>		-	10	20	
<b>Drain-Source Body Diode Characteristi</b>	cs		L	<u> </u>		
Continuous source-drain diode current	Is	T <sub>C</sub> = 25 °C	-	-	41	А
Pulse diode forward current <sup>a</sup>	I <sub>SM</sub>		-	-	130	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = 10 A	-	0.77	1.1	V
Body diode reverse recovery time	t <sub>rr</sub>	-	-	20	40	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	7	20	nC
Reverse recovery fall time	ta	$T_{\rm J} = 25  ^{\circ}{\rm C}$	-	10	-	ns
Reverse recovery rise time	t <sub>b</sub>		-	10	-	

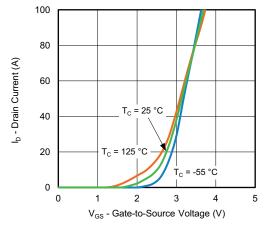
#### Notes

- a. Pulse test: pulse width  $\leq 300~\mu\text{s},$  duty cycle  $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. Based on characterization, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

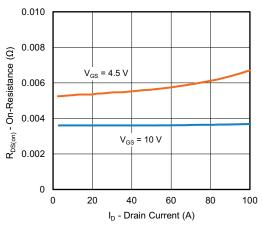


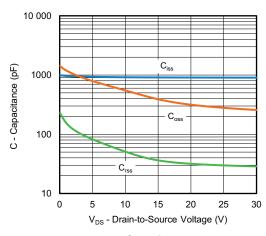






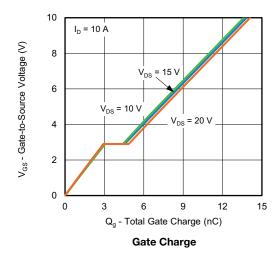


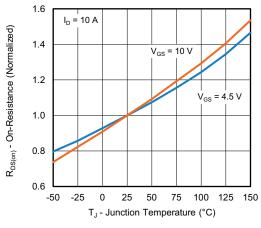




On-Resistance vs. Drain Current

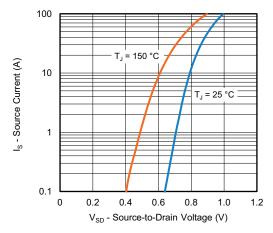




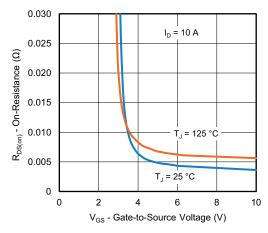


On-Resistance vs. Junction Temperature

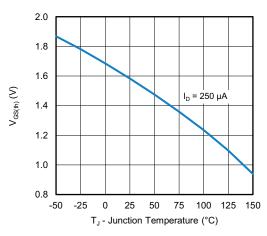




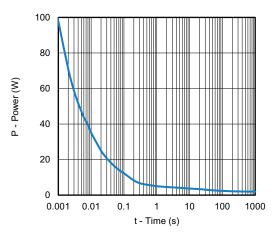
Source-Drain Diode Forward Voltage



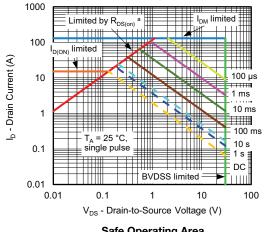
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 



Single Pulse Power, Junction-to-Ambient

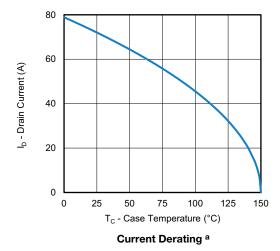


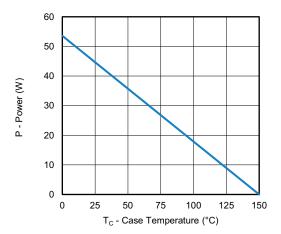
Safe Operating Area

#### Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified





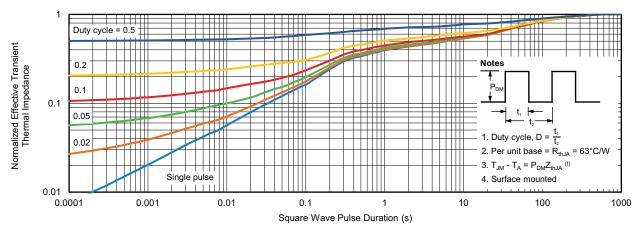


Power, Junction-to-Case

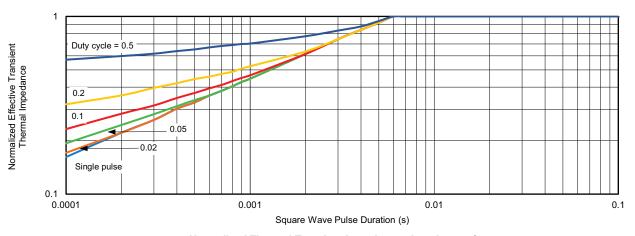
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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## RECOMMENDED MINIMUM PADS FOR PowerPAK® 1212-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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